BGA Heat Sink - High Performance ASIC Cooling





ATS Part#: **ATS-56012-C1-R0**

Description: 42.00 x 42.00 x 16.00 mm BGA Heat Sink - High Performance ASIC Cooling

Heat Sink Type: ASIC Cooling
Heat Sink Attachment: Thermal Tape
Equivalent Part Number: ATS-56012-C3-R0

*Image above is for illustration purpose only.

Features & Benefits

- maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- · Designed specifically for ASIC package and their unique cooling requirements
- · Comes preassembled with high performance thermal interface material

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	2.8 °C/W	2.1 °C/W	1.77 °C/W	1.57 °C/W	1.43 °C/W	1.33 °C/W	1.25 °C/W
	Ducted Flow	1.4	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail



